

Data issued: June 28, 2023
Valid period: 12 months

Bulletin

We, CHIMEI CORPORATION, to the best of our knowledge hereby certify that the resins listed below (hereinafter referred as "products") as directly manufactured by us

POLYLAC® ABS (J01, J04, A01, A03) PA-704LRP, PA-705, PA-707, PA-707 J04, PA-709, PA-709H, PA-709K, PA-709P, PA-709S, PA-716, PA-717C, PA-718, PA-726, PA-726M, PA-727, PA-737, PA-737 A03, PA-746, PA-746H, PA-746M, PA-746Y, PA-747, PA-747F, PA-747H, PA-747R, PA-747S, PA-747S A01, PA-749, PA-749S, PA-756, PA-756S, PA-756H, PA-757, PA-757 A01, PA-757 AB, PA-757F, PA-757G J08, PA-757H, PA-757N, PA-757K, PA-777B, PA-777C, PA-777D, PA-777E, PA-77NB, PA-797, PA-797S (J01 & J04) - The suffix may be used to denote the black color grade manufactured from CHIMEI Corp. (A01 & A03) - The suffix may be used to denote the white color grade manufactured from CHIMEI Corp.

POLYLAC® MABS PA-703TRP, PA-758, PA-758R, LS-L230

KIBISAN® SAN PN-106, PN-107, PN-117, PN-117C, PN-117H, PN-127, PN-127H, PN-137H, PN-106 L150 FG, PN-107 L125 FG, PN-117 L200 FG, PN-127 L150 FG

POLYREX® PS PG-33, PG-383D, PH-55Y, PH-88, PH-88S, PH-888G

ACRYREX® PMMA CM-205, CM-205G, CM-205M, CM-205N, CM-207, CM-207G, CM-211, CM-211G, CM-220HT

ACRYSTEX® SMMA PM-500G, PM-600, PM-700G

KIBITON® TPE PB-511, PB-575, PB-585, PB-587, PB-5301, PB-5302, PB-5502

KIBITON® Q-resin PB-5903

KIBIPOL® LBR/SSBR/HBR PR-040, PR-040C, PR-040G, PR-050, PR-255, PR-303, PR-1205

ACRYPOLY® CM-205B, CM-205X, PM-500X, LM-700X

The above statement is based on our current level of knowledge and covers the above products directly manufactured and supplied by CHIMEI CORPORATION at the date of issue. CHIMEI CORPORATION makes no warranties, whether express or implied, and assumes no liability in connection with any use of above information. Notwithstanding the foregoing, CHIMEI CORPORATION shall in no event be held obligated or liable for any claims due to or arising from (i) any customer provided, consigned, materials and/or parts, which are incorporated or adopted in the products; (ii) any combination of the products with material not provided or authorized by our company; (iii) any modifications to the products which are made or directed by customer; (iv) our compliance with the specifications, instructions, and/or designs provided by customer; (v) any anti-trust, unfair competition and/or other unlawful actions effected by customer; or (vi) any defects, infringement, breach and/or violation which are arising out of customer's faults or otherwise not solely and directly attributable to CHIMEI CORPORATION. In no event will CHIMEI CORPORATION be liable for any indirect, special, exemplary, punitive and/or consequential damages (including lost profits) of any nature whatsoever whether arising out of the purchase, shipment, loading, handling, or use of any product or otherwise.

KIBILITE®

DC-552F, DC-552G, DC-553F, DC-603F, DM-000B, DM-551M, DM-553B, DM-601M, DM-601R, DS-551A, DS-553A, DS-553C, DS-553H, DS-601S, DS-601Y, DS-603A, DS-603C, DS-653A, DS-653C, DS-743B, DS-753B, DS-903A, DS-903E, DS-903H, DS-943A, DS-943B, DS-943G, DS-943H, DS-943I, DS-963E, DS-963G

KIBILAC®

PW-957, PW-978B, PW-978D, PW-978W, PW-997, PW-997G, PW-997S

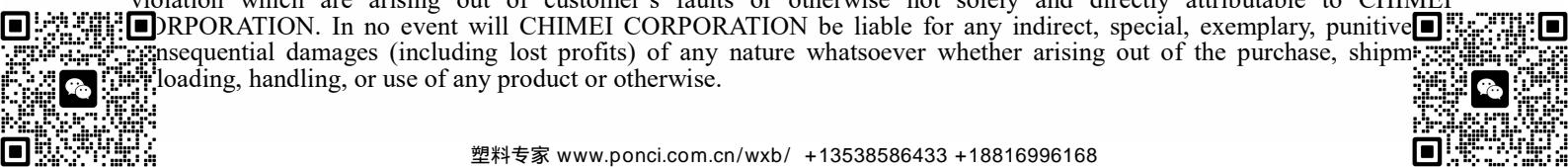
Ecologue™ Bio ABS

PA-757 B50, PA-757 B70, PA-757F B50

conforms to the requirement that no chemicals as following are intentionally added.

1. Halogen (F, Br, I)
2. Halogen (Cl)
3. PBDEs (Polybrominated Diphenyl Ethers)
4. PBBs (Polybrominated Biphenyls)
5. Ozone Depleting Chemicals (CFCs & HCFCs)
6. Chlorinated Paraffin (C10-C13)
7. Polyvinyl Chloride (PVC)
8. Mercury (Hg) and its compounds
9. Lead (Pb) and its compounds
10. Cadmium (Cd) and its compounds
11. Chromium (Cr) and its compounds
12. Arsenic (As) and its compounds
13. Antimony (Sb) and its compounds
14. Selenium (Se) and its compounds
15. Barium (Ba) and its compounds
16. Beryllium (Be) and its compounds
17. Bismuth (Bi) and its compounds
18. Organic tin compounds (TBT, TPT, DOT, DBT)
19. Polychlorinated Biphenyls (PCBs) and Terphenyls (PCTs) and Napthalenes (PCNs)
20. Poly naphthalenes
21. Azo colorants (according to REACH-ANNEX-XVII-APPENDIX 8)
22. Asbestos
23. Phthalates
38. Hexachlorobenzene
39. Mirex
40. Specified amine compounds
41. Benzene
42. Benzenamine, N-phenyl-, Reaction Products with Styrene and 2,4,4-Trimethylpentene (BNST)
43. Polyamide
44. PVDC (polyvinylidene chloride)
45. ESBO (Expoxydized soybean oil)
46. Formamide
47. Hexabromocyclododecane (HBCDD)
48. Red phosphorus
49. Aniline · formaldehyde polycondensate
50. Fluorescent powder
51. 4,4'-Sulfonyldiphenol (BPS)
52. Tris(1-chloro-2-propyl)phosphate (TCPP)
53. Tris(1,3-dichloro-2-propyl)phosphate (TDCPP)
54. Tris (2,3-dibromopropyl) phosphate
55. Tris (aziridinyl) phosphinoxide
56. Tri-o-cresyl phosphate
57. Tris (2-chloroethyl) phosphate (TCEP)
58. Perfluorohexane-1-sulphonic acid and its salts (PFHxS)
59. Diisononyl phthalate (DINP)

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- 24. APEO: Including Alkylphenol(AP), Octylphenol(OP), Nonylphenol(NP), Octylphenol ethoxylates(OPE), Nonylphenol ethoxylates(NPE)
- 25. 2-(2'-Hydroxy-3',5'-di-tert-butylphenyl)benzotriazole
- 26. Perfluorooctanoic acid(PFOA) and its compounds, Perfluorooctane sulfonate(PFOS) and its compounds, Per- and polyfluoroalkyl substances(PFAS) and its compounds
- 27. Bisphenol A
- 28. Formaldehyde
- 29. Dimethylfumarate (DMF)
- 30. Triclosan
- 31. Nickel
- 32. REACH- Candidate List of 235 SVHCs(2023/06/14)
- 33. Radioactive Substances
- 34. Natural Latex
- 35. Dioxins and furans
- 36. Primary aromatic amines (PAA)
- 37. Perchlorate
- 60. Di-isodecyl phthalate (DIDP)
- 61. Di-n-octyl phthalate (DnOP)
- 62. Diethyl phthalate (DEP)
- 63. Dimethyl phthalate (DMP)
- 64. Cobalt
- 65. Mica
- 66. Graphite
- 67. Bis (2-ethylhexyl) phthalate (DEHP)
- 68. Butyl benzyl phthalate (BBP)
- 69. Dibutyl phthalate (DBP)
- 70. Diisobutyl phthalate (DIBP)
- 71. PIP (3:1) (phenol, isopropylated phosphate 3:1)
- 72. DecaBDE (deca bromodiphenyl ether)
- 73. 2,4,6-TTBP (2,4,6-Tris(tert-butyl)phenol)
- 74. HCBD (hexachlorobutadiene)
- 75. PCTP (pentachlorothiophenol)
- 76. PFCAs(C9-C21 perfluorocarboxylic acids) & PFNA(Perfluorononan-1-oic-acid and its sodium and ammonium salts)
- 77. Methylene chloride

With regard to composition of above grades of products, the aforesaid products comply with the Directives of RoHS 2011/65/EU and its amendment (EU) 2015/863, TCO'07, Blue Angel and SONY Standard (SS-00259)

Sincerely Yours,

Jones Kuo

Jones Kuo

Vice President of Research and Development Head Division

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